

## Features

- Fast Read Access Time - 70 ns
- Word-wide or Byte-wide Configurable
- 4 Megabit Flash and Mask ROM Compatible
- Low Power CMOS Operation
  - 100  $\mu$ A Maximum Standby
  - 50 mA Maximum Active at 5 MHz
- Wide Selection of JEDEC Standard Packages
  - 40-Lead 600 mil PDIP
  - 44-Lead SOIC (SOP)
  - 48-Lead TSOP (12 mm x 20 mm)
- 5V  $\pm$  10% Power Supply
- High Reliability CMOS Technology
  - 2,000V ESD Protection
  - 200 mA Latchup Immunity
- Rapid™ Programming Algorithm - 50  $\mu$ s/word (typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Commercial and Industrial Temperature Ranges

## Description

The AT27C400 is a low-power, high-performance 4,194,304-bit one-time programmable read only memory (OTP EPROM) organized as either 256K by 16 or 512K by 8 bits. It requires a single 5V power supply in normal read mode operation. Any word can be accessed in less than 70 ns, eliminating the need for speed-reducing WAIT states. The by-16 organization makes this part ideal for high-performance 16- and 32-bit microprocessor systems.

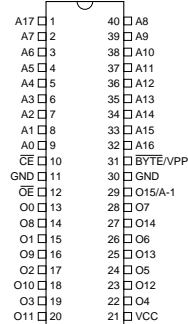
(continued)

## Pin Configurations

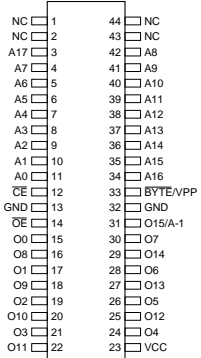
Pin Name	Function
A0 - A17	Addresses
O0 - O15	Outputs
O15/A-1	Output/Address
BYTE/VPP	Byte Mode/ Program Supply
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
NC	No Connect

Note: Both GND pins must be connected.

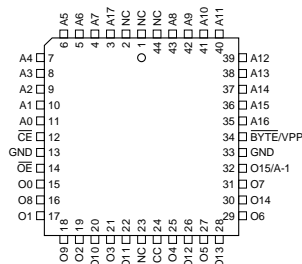
PDIP Top View



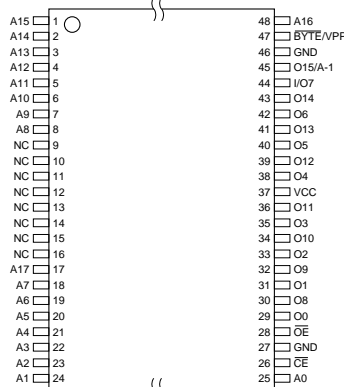
SOIC (SOP)



PLCC



TSOP  
Type 1



Rev. 0844B-10/98



## 4-Megabit (256K x 16 or 512K x 8) OTP EPROM

## AT27C400 Preliminary



The AT27C400 can be organized as either word-wide or byte-wide. The organization is selected via the  $\overline{\text{BYTE}}/\text{V}_{\text{PP}}$  pin. When  $\overline{\text{BYTE}}/\text{V}_{\text{PP}}$  is asserted high ( $\text{V}_{\text{IH}}$ ), the word-wide organization is selected and the O15/A-1 pin is used for O15 data output. When  $\overline{\text{BYTE}}/\text{V}_{\text{PP}}$  is asserted low ( $\text{V}_{\text{IL}}$ ), the byte-wide organization is selected and the O15/A-1 pin is used for the address pin A-1. When the AT27C400 is logically regarded as x16 (word-wide), but read in the byte-wide mode, then with  $\text{A}-1 = \text{V}_{\text{IL}}$  the lower 8 bits of the 16-bit word are selected and with  $\text{A}-1 = \text{V}_{\text{IH}}$  the upper 8 bits of the 16-bit word are selected.

In read mode, the AT27C400 typically consumes 15 mA. Standby mode supply current is typically less than 10  $\mu\text{A}$ .

The AT27C400 is available in industry standard JEDEC-approved one-time programmable (OTP) PDIP, SOIC (SOP), and TSOP packages. The device features two-line control ( $\overline{\text{CE}}$ ,  $\overline{\text{OE}}$ ) to eliminate bus contention in high-speed systems.

With high density 256K word or 512K byte storage capability, the AT27C400 allows firmware to be stored reliably and to be accessed by the system without the delays of mass storage media.

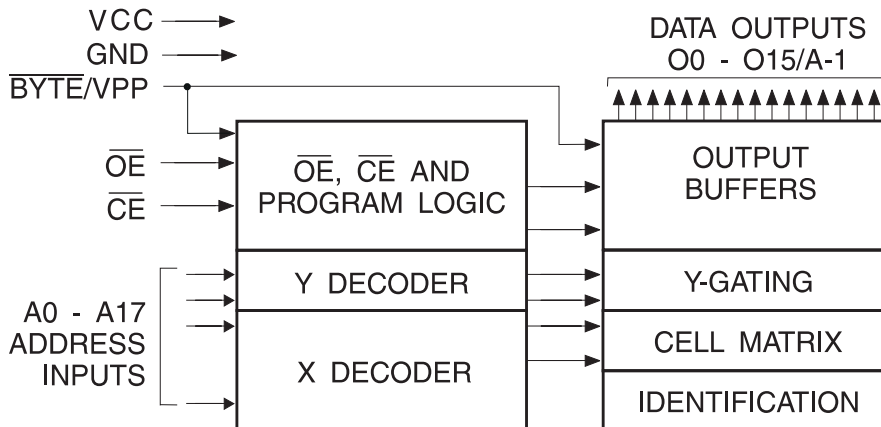
Atmel's AT27C400 has additional features that ensure high quality and efficient production use. The Rapid™ Program-

ming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 50  $\mu\text{s}$ /word. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages.

## System Considerations

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed data sheet limits, resulting in device non-conformance. At a minimum, a 0.1  $\mu\text{F}$  high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the  $\text{V}_{\text{CC}}$  and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7  $\mu\text{F}$  bulk electrolytic capacitor should be utilized, again connected between the  $\text{V}_{\text{CC}}$  and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

## Block Diagram



## Absolute Maximum Ratings\*

Temperature Under Bias .....	-55°C to +125°C
Storage Temperature .....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground .....	-2.0V to +7.0V <sup>(1)</sup>
Voltage on A9 with Respect to Ground .....	-2.0V to +14.0V <sup>(1)</sup>
V <sub>PP</sub> Supply Voltage with Respect to Ground .....	-2.0V to +14.0V <sup>(1)</sup>
Integrated UV Erase Dose.....	.7258 W •sec/cm <sup>2</sup>

\*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V dc which undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V<sub>CC</sub> + 0.75V dc which may overshoot to +7.0V for pulses of less than 20 ns.

## Operating Modes

Mode/Pin	$\overline{\text{CE}}$	$\overline{\text{OE}}$	Ai	$\overline{\text{BYTE}}/\text{V}_{\text{PP}}$	Outputs		
					O <sub>0</sub> - O <sub>7</sub>	O <sub>8</sub> - O <sub>14</sub>	O <sub>15</sub> /A-1
Read Word-wide	V <sub>IL</sub>	V <sub>IL</sub>	X <sup>(1)</sup>	V <sub>IH</sub>	D <sub>OUT</sub>	D <sub>OUT</sub>	D <sub>OUT</sub>
Read Byte-wide Upper	V <sub>IL</sub>	V <sub>IL</sub>	X <sup>(1)</sup>	V <sub>IL</sub>	D <sub>OUT</sub>	High Z	V <sub>IH</sub>
Read Byte-wide Lower	V <sub>IL</sub>	V <sub>IL</sub>	X <sup>(1)</sup>	V <sub>IL</sub>	D <sub>OUT</sub>	High Z	V <sub>IL</sub>
Output Disable	X <sup>(1)</sup>	V <sub>IH</sub>	X <sup>(1)</sup>	X		High Z	
Standby	V <sub>IH</sub>	X <sup>(1)</sup>	X <sup>(1)</sup>	X <sup>(5)</sup>		High Z	
Rapid Program <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	V <sub>PP</sub>		D <sub>IN</sub>	
PGM Verify	X	V <sub>IL</sub>	Ai	V <sub>PP</sub>		D <sub>OUT</sub>	
PGM Inhibit	V <sub>IH</sub>	V <sub>IH</sub>	X <sup>(1)</sup>	V <sub>PP</sub>		High Z	
Product Identification <sup>(4)</sup>	V <sub>IL</sub>	V <sub>IL</sub>	A9 = V <sub>H</sub> <sup>(3)</sup> A0 = V <sub>IH</sub> or V <sub>IL</sub> A1 - A17 = V <sub>IL</sub>	V <sub>IH</sub>		Identification Code	

- Notes: 1. X can be V<sub>IL</sub> or V<sub>IH</sub>.  
2. Refer to the programming characteristics tables in this data sheet.  
3. V<sub>H</sub> = 12.0 ± 0.5V.  
4. Two identifier words may be selected. All inputs are held low (V<sub>IL</sub>), except A9, which is set to V<sub>H</sub>, and A0, which is toggled low (V<sub>IL</sub>) to select the Manufacturer's Identification word and high (V<sub>IH</sub>) to select the Device Code word.  
5. Standby V<sub>CC</sub> current (ISB) is specified with V<sub>PP</sub> = V<sub>CC</sub>. V<sub>CC</sub> > V<sub>PP</sub> will cause a slight increase in ISB.

## DC and AC Operating Conditions for Read Operation

		AT27C400			
		-70	-90	-12	-15
Operating Temperature (Case)	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	0°C - 70°C
	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
V <sub>CC</sub> Power Supply		5V ± 10%	5V ± 10%	5V ± 10%	5V ± 10%

## DC and Operating Characteristics for Read Operation

Symbol	Parameter	Condition	Min	Max	Units
I <sub>LI</sub>	Input Load Current	V <sub>IN</sub> = 0V to V <sub>CC</sub>		± 1	μA
I <sub>LO</sub>	Output Leakage Current	V <sub>OUT</sub> = 0V to V <sub>CC</sub>		± 5	μA
I <sub>PP1</sub> <sup>(2)</sup>	V <sub>PP</sub> <sup>(1)</sup> Read/Standby Current	V <sub>PP</sub> = V <sub>CC</sub>		10	μA
I <sub>SB</sub>	V <sub>CC</sub> <sup>(1)</sup> Standby Current	I <sub>SB1</sub> (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$		100	μA
		I <sub>SB2</sub> (TTL), $\overline{CE} = 2.0$ to V <sub>CC</sub> + 0.5V		1	mA
	V <sub>CC</sub> Active Current	f = 5 MHz, I <sub>OUT</sub> = 0 mA, $\overline{CE} = V_{IL}$		40	mA
V <sub>IL</sub>	Input Low Voltage		-0.6	0.8	V
V <sub>IH</sub>	Input High Voltage		2.0	V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA		0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA	2.4		V

- Notes: 1. V<sub>CC</sub> must be applied simultaneously or before V<sub>PP</sub> and removed simultaneously or after V<sub>PP</sub>  
2. V<sub>PP</sub> may be connected directly to V<sub>CC</sub>, except during programming. The supply current would then be the sum of I<sub>CC</sub> and I<sub>PP</sub>

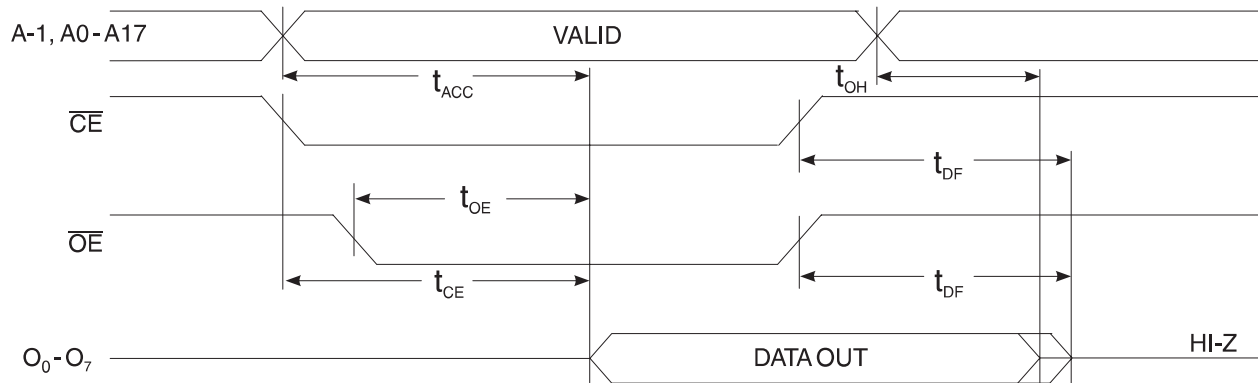
## AC Characteristics for Read Operation

Symbol	Parameter	Condition	AT27C400								Units
			-70		-90		-12		-15		
			Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>ACC</sub> <sup>(2)</sup>	Address to Output Delay	$\overline{CE} = \overline{OE}$ = V <sub>IL</sub>		70		90		120		150	ns
t <sub>CE</sub> <sup>(2)</sup>	$\overline{CE}$ to Output Delay	$\overline{OE} = V_{IL}$		70		90		120		150	ns
t <sub>OE</sub> <sup>(2)(3)</sup>	$\overline{OE}$ to Output Delay	$\overline{CE} = V_{IL}$		30		35		40		50	ns
t <sub>DF</sub> <sup>(4)(5)</sup>	$\overline{OE}$ or $\overline{CE}$ High to Output Float, whichever occurred first			20		20		30		35	ns
t <sub>OH</sub> <sup>(4)</sup>	Output Hold from Address, $\overline{CE}$ or $\overline{OE}$ , whichever occurred first		5		5		5		5		ns
t <sub>ST</sub>	$\overline{BYTE}$ High to Output Valid			70		90		120		150	ns
t <sub>STD</sub>	$\overline{BYTE}$ Low to Output Transition			40		40		50		60	ns

Note: 2, 3, 4, 5. See the AC Waveforms for Read Operation diagram.

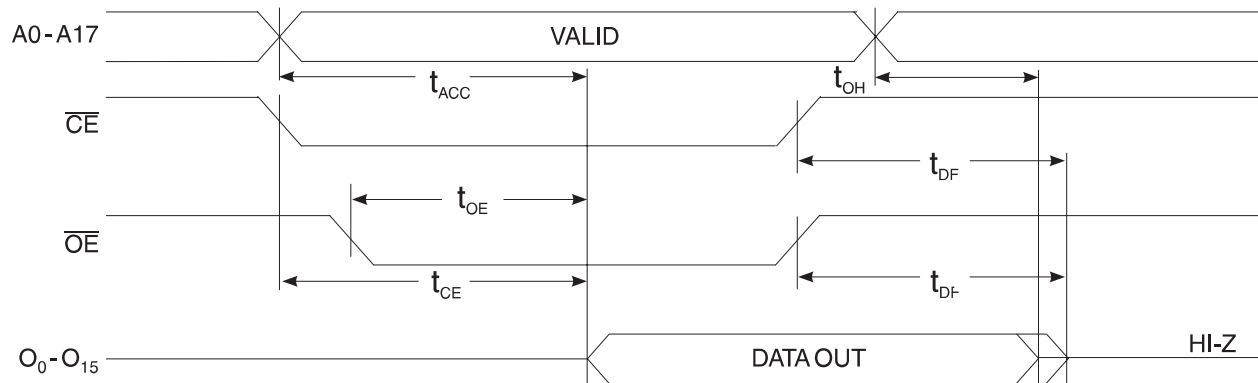
 = Advance Information

## Byte-Wide Read Mode AC Waveforms



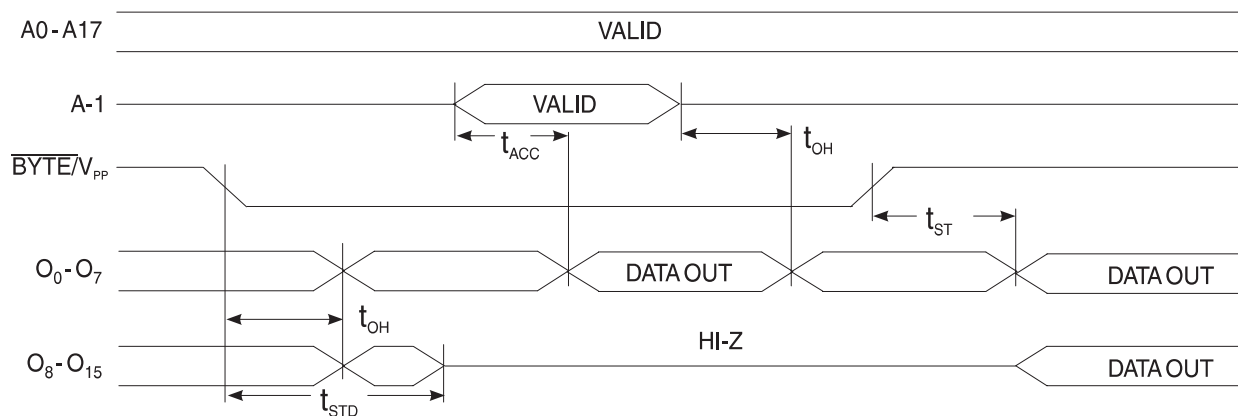
Note:  $\overline{BYTE}/V_{PP} = V_{IL}$

## Word-Wide Read Mode AC Waveforms



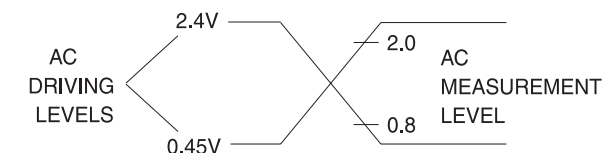
Note:  $\overline{BYTE}/V_{PP} = V_{IH}$

## $\overline{BYTE}$ Transition AC Waveforms



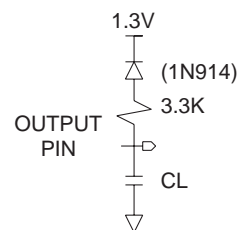
- Notes:
1. Timing measurement references are 0.8V and 2.0V. Input AC drive levels are 0.45V and 2.4V, unless otherwise specified.
  2.  $\overline{OE}$  may be delayed up to  $t_{CE} - t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$ .
  3.  $\overline{OE}$  may be delayed up to  $t_{ACC} - t_{OE}$  after the address is valid without impact on  $t_{ACC}$ .
  4. This parameter is only sampled and is not 100% tested.
  5. Output float is defined as the point when data is no longer driven.

## Input Test Waveforms and Measurement Levels



$t_R, t_F < 20 \text{ ns}$  (10% to 90%)

## Output Test Load



Note:  $C_L = 100 \text{ pF}$  including jig capacitance.

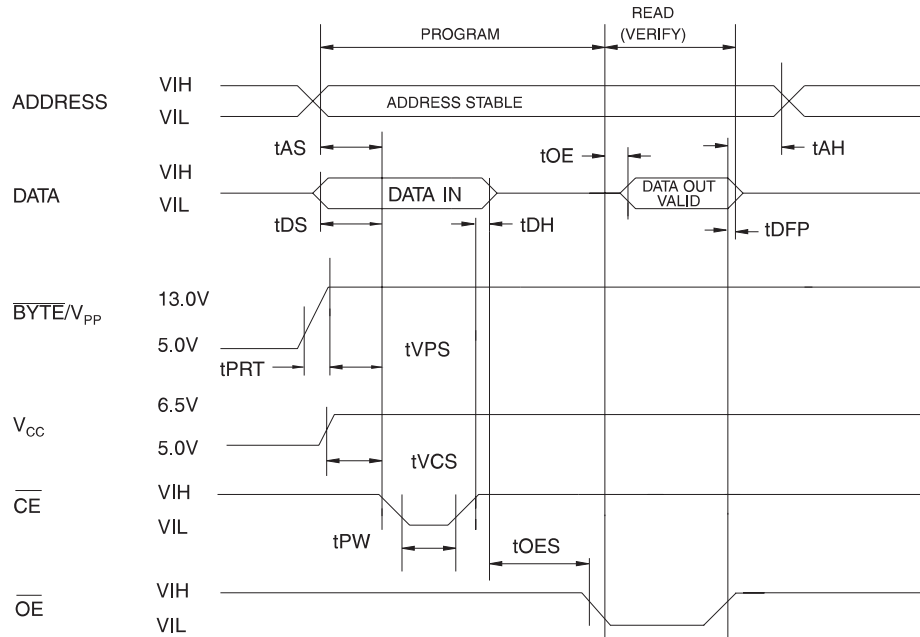
## Pin Capacitance

$f = 1 \text{ MHz}$ ,  $T = 25^\circ\text{C}^{(1)}$

Symbol	Typ	Max	Units	Conditions
$C_{IN}$	4	10	pF	$V_{IN} = 0V$
$C_{OUT}$	8	12	pF	$V_{OUT} = 0V$

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

## Programming Waveforms<sup>(1)</sup>



- Notes:
1. The Input Timing Reference is 0.8V for V<sub>IL</sub> and 2.0V for V<sub>IH</sub>.
  2. t<sub>OE</sub> and t<sub>DFP</sub> are characteristics of the device but must be accommodated by the programmer.
  3. When programming the AT27C400, a 0.1  $\mu$ F capacitor is required across V<sub>PP</sub> and ground to suppress spurious voltage transients.

## DC Programming Characteristics

T<sub>A</sub> = 25  $\pm$  5°C, V<sub>CC</sub> = 6.5  $\pm$  0.25V, V<sub>PP</sub> = 13.0  $\pm$  0.25V

Symbol	Parameter	Test Conditions	Limits		Units
			Min	Max	
I <sub>LI</sub>	Input Load Current	V <sub>IN</sub> = V <sub>IL</sub> , V <sub>IH</sub>		$\pm$ 10	$\mu$ A
V <sub>IL</sub>	Input Low Level		-0.6	0.8	V
V <sub>IH</sub>	Input High Level		2.0	V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA		0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 $\mu$ A	2.4		V
I <sub>CC2</sub>	V <sub>CC</sub> Supply Current (Program and Verify)			50	mA
I <sub>PP2</sub>	V <sub>PP</sub> Supply Current	$\overline{\text{CE}}$ = V <sub>IL</sub>		30	mA
V <sub>ID</sub>	A9 Product Identification Voltage		11.5	12.5	V

## AC Programming Characteristics

$T_A = 25 \pm 5^\circ\text{C}$ ,  $V_{CC} = 6.5 \pm 0.25\text{V}$ ,  $V_{PP} = 13.0 \pm 0.25\text{V}$

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Limits		Units
			Min	Max	
$t_{AS}$	Address Setup Time	Input Rise and Fall Times: (10% to 90%) 20 ns	2		$\mu\text{s}$
$t_{OES}$	$\overline{OE}$ Setup Time		2		$\mu\text{s}$
$t_{DS}$	Data Setup Time		2		$\mu\text{s}$
$t_{AH}$	Address Hold Time	Input Pulse Levels: 0.45V to 2.4V	0		$\mu\text{s}$
$t_{DH}$	Data Hold Time		2		$\mu\text{s}$
$t_{DFP}$	$\overline{OE}$ High to Output Float Delay <sup>(2)</sup>	Input Timing Reference Level: 0.8V to 2.0V	0	130	ns
$t_{VPS}$	$V_{PP}$ Setup Time		2		$\mu\text{s}$
$t_{VCS}$	$V_{CC}$ Setup Time	Output Timing Reference Level: 0.8V to 2.0V	2		$\mu\text{s}$
$t_{PW}$	$\overline{CE}$ Program Pulse Width <sup>(3)</sup>		47.5	52.5	$\mu\text{s}$
$t_{OE}$	Data Valid from $\overline{OE}$			150	ns
$t_{PRT}$	$\overline{BYTE}/V_{PP}$ Pulse Rise Time During Programming		50		ns

- Notes:
- $V_{CC}$  must be applied simultaneously or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$
  - This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven — see timing diagram.
  - Program Pulse width tolerance is  $50 \mu\text{sec} \pm 5\%$ .

## Atmel's 27C400 Integrated Product Identification Code

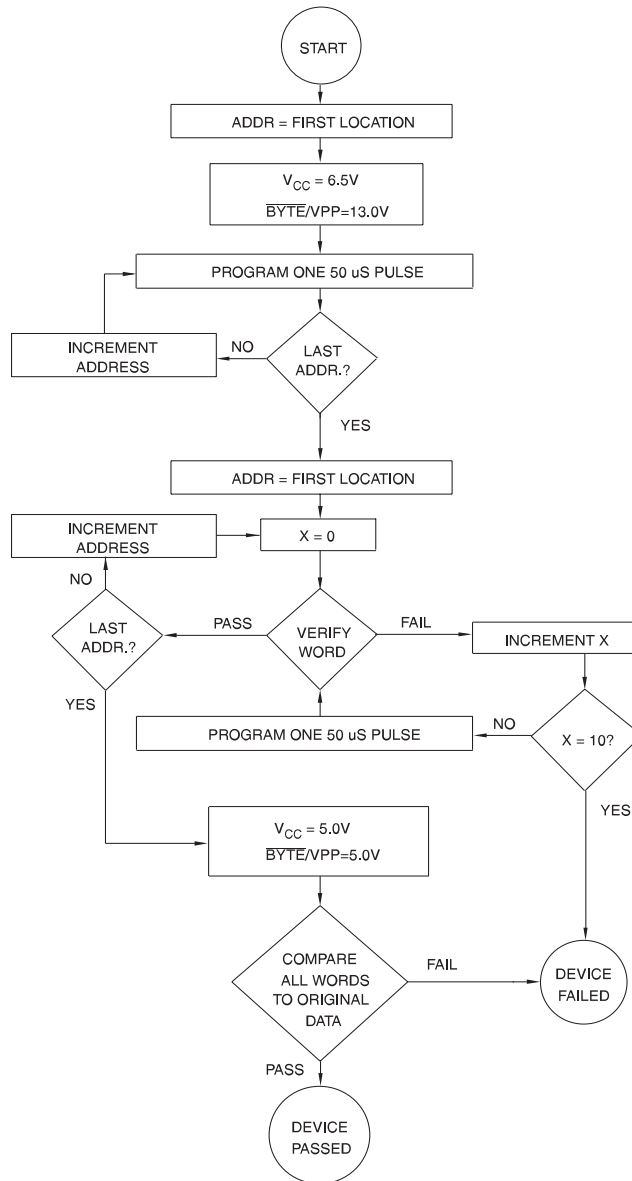
Codes	Pins									Hex Data
	A0	O15	O14	O13	O12	O11	O10	O9	O8	
		O7	O6	O5	O4	O3	O2	O1	O0	
Manufacturer	0	0	0	0	1	1	1	1	0	1E1E
Device Type	1	1	1	1	1	0	1	0	0	F4F4



## Rapid Programming Algorithm

A 50  $\mu\text{s}$   $\overline{\text{CE}}$  pulse width is used to program. The address is set to the first location.  $V_{\text{CC}}$  is raised to 6.5V and  $\overline{\text{BYTE}}/V_{\text{PP}}$  is raised to 13.0V. Each address is first programmed with one 50  $\mu\text{s}$   $\overline{\text{CE}}$  pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a word fails to pass verification, up to 10 successive 50  $\mu\text{s}$  pulses are applied with a verification after each

pulse. If the word fails to verify after 10 pulses have been applied, the part is considered failed. After the word verifies properly, the next address is selected until all have been checked.  $V_{\text{PP}}$  is then lowered to 5.0V and  $V_{\text{CC}}$  to 5.0V. All words are read again and compared with the original data to determine if the device passes or fails.



## Ordering Information

t <sub>ACC</sub> (ns)	I <sub>CC</sub> (mA)		Ordering Code	Package	Operation Range
	Active	Standby			
70	40	0.1	AT27C400-70PC AT27C400-70RC AT27C400-70TC AT27C400-70JC	40P6 44R 48T 44J	Commercial (0°C to 70°C)
	40	0.1	AT27C400-70PI AT27C400-70RI AT27C400-70TI AT27C400-70JI	40P6 44R 48T 44J	Industrial (-40°C to 85°C)
90	40	0.1	AT27C400-90PC AT27C400-90RC AT27C400-90TC AT27C400-90JC	40P6 44R 48T 44J	Commercial (0°C to 70°C)
	40	0.1	AT27C400-90PI AT27C400-90RI AT27C400-90TI AT27C400-90JI	40P6 44R 48T 44J	Industrial (-40°C to 85°C)
120	40	0.1	AT27C400-12PC AT27C400-12RC AT27C400-12TC AT27C400-12JC	40P6 44R 48T 44J	Commercial (0°C to 70°C)
	40	0.1	AT27C400-12PI AT27C400-12RI AT27C400-12TI AT27C400-12JI	40P6 44R 48T 44J	Industrial (-40°C to 85°C)
150	40	0.1	AT27C400-15PC AT27C400-15RC AT27C400-15TC AT27C400-15JC	40P6 44R 48T 44J	Commercial (0°C to 70°C)
	40	0.1	AT27C400-15PI AT27C400-15RI AT27C400-15TI AT27C400-15JI	40P6 44R 48T 44J	Industrial (-40°C to 85°C)

 = Advance Information

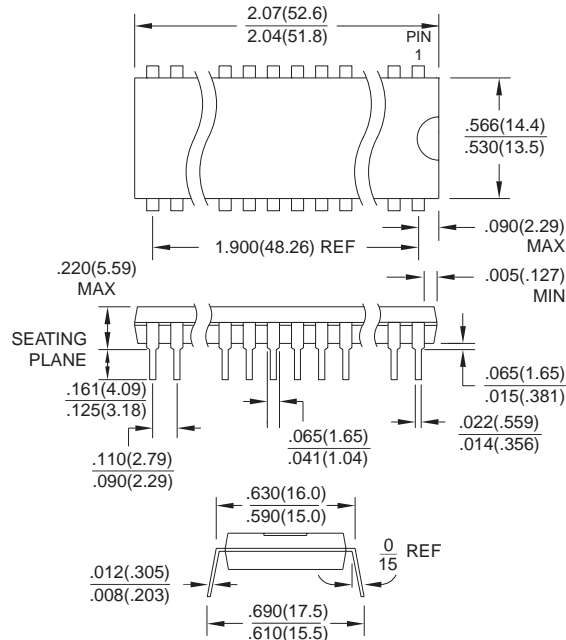
Package Type	
<b>40P6</b>	40-Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)
<b>44R</b>	44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline Package (SOIC/SOP)
<b>48T</b>	48-Lead, Plastic Thin Small Outline Package (TSOP) 12 x 20 mm
<b>44J</b>	44-Lead, Plastic J-Leaded Chip Carrier (PLCC)

## Packaging Information

### 40P6, 40-Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)

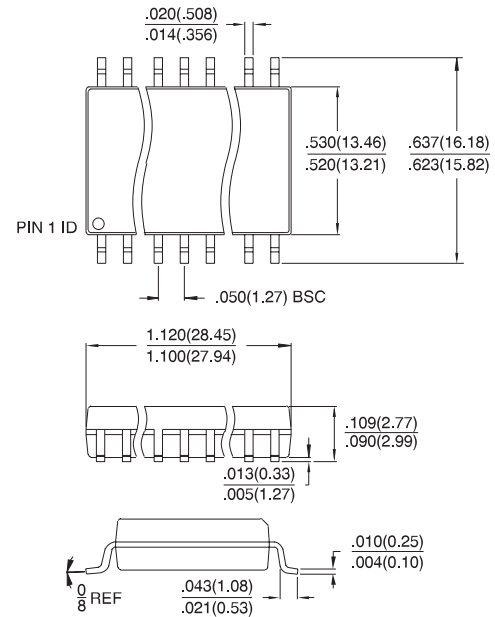
Dimensions in Inches and (Millimeters)

JEDEC STANDARD MS-011 AC



### 44R, 44-Lead, 0.525" Wide, Plastic Gull Wing Small Outline (SOIC)

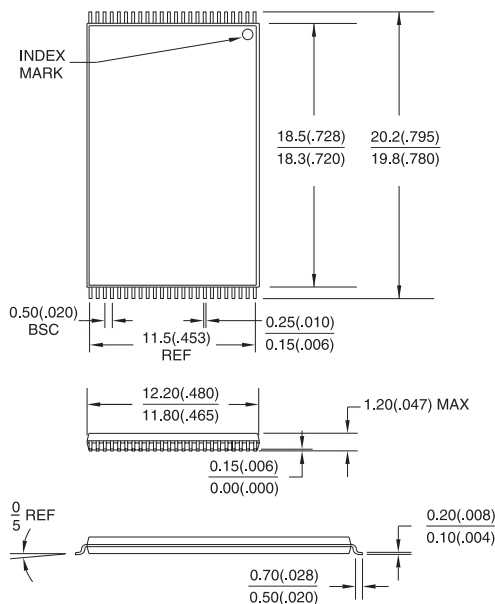
Dimensions in Inches and (Millimeters)



### 48T, 48-Lead, Plastic Thin Small Outline Package (TSOP)

Dimensions in Millimeters and (Inches)\*

JEDEC OUTLINE MO-142 DD

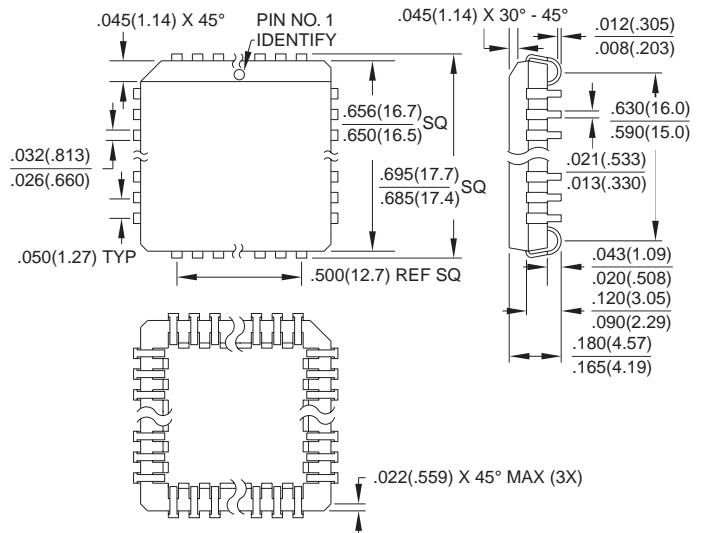


\*Controlling dimension: millimeters

### 44J, 44-Lead, Plastic J-Leaded Chip Carrier (PLCC)

Dimensions in Inches and (Millimeters)

JEDEC STANDARD MS-018 AC





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